TOSHIBA MG1200V1US51

TOSHIBA GTR MODULE SILICON N-CHANNEL IGBT

MG1200V1US51

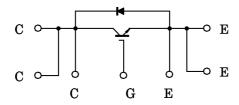
HIGH POWER SWITCHING APPLICATIONS

MOTOR CONTROL APPLICATIONS

FEATURES

- High Input Impedance
- Enhancement Mode
- Electrodes are isolated from case.

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (Ta = 25°C)

TO CHILLIAN TO CHILLES (Tu = 23 G)									
CHARA	CTERISTICS	SYMBOL	RATING	UNIT					
Collector-Emitter Voltage		$v_{\rm CES}$	1700	V					
Gate-Emitter Voltage		V _{GES}	20	V					
Collector Current	DC	$I_{\mathbf{C}}$	1200	A					
	1ms	I_{CP}	2400						
Forward Current	DC	$I_{\mathbf{F}}$	1200	A					
	1ms	I_{FM}	2400						
Collector Power Di	ssipation (Tc=25°C)	PC	5560	W					
Junction Temperat	ure	Tj	-20~125	°C					
Storage Temperature Range		T _{stg}	-40~125	°C					
Isolation Voltage		V_{Isol}	5400 (AC 1min.)	V					
Company Tomana	Terminal: M4/M8		2/7	N·m					
Screw Torque	Mounting	7 –	4						

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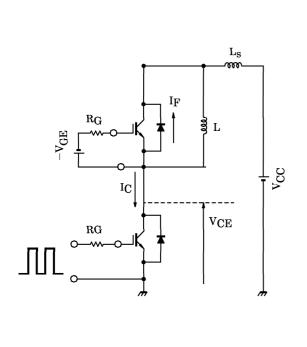
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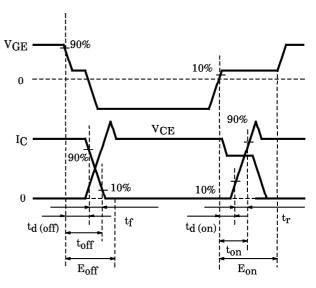
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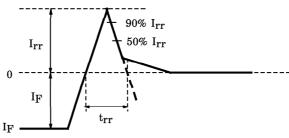
ELECTRICAL CHARACTERISTICS (Tc = 125°C : except thermal resistance)

CHARACTERISTICS		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Laekage Current		I_{GES}	$V_{GE} = \pm 20V, V_{CE} = 0V$	_	_	±50	nA
Collector Cut-Off Current		ICES	$V_{CE} = 1700V, V_{GE} = 0V$	_	_	100	mA
Gate-Emitter Cut-Off Voltage		V _{GE (off)}	$V_{CE} = 5V, I_{C} = 1.2A$	3.0		7.0	V
Collecter-Emitter Saturation Voltage		V _{CE} (sat)	$V_{GE} = 15V, I_{C} = 1200A$	_	_	5.0	V
Input Capacitance		Cies	$V_{\text{CE}} = 10\text{V}, V_{\text{GE}} = 0\text{V},$ f=300kHz	_	130	_	nF
Switching Time (Note 1)	Rise Time	$t_{\mathbf{r}}$	$V_{CC} = 900V, I_{C} = 1200A$		_	0.7	μ s
	Turn-On Time	t_{on}	$ m V_{GE} = \pm 15V, R_G = 1.8\Omega$		_	1.0	μ s
	Fall Time	$t_{\mathbf{f}}$	(Inductive load : Ls=150nH)	_	_	0.8	μs
	Turn-Off Time	$t_{ m off}$		_	_	1.5	μs
Forward Voltage		$V_{\mathbf{F}}$	$I_{F} = 1200A, V_{GE} = 0V$	_	_	3.2	V
Reverse Recovery Time (Note 1)		t _{rr}	$I_F = 1200A, V_{GE} = 15V$ di / dt = 4000A / μ s, $V_{CC} = 900V$	_	_	0.8	μs
Switching	Turn-On Loss	Eon	$V_{CC} = 900V, I_{C} = 1200A$	_	250	_	mJ
Dissipation	Turn-Off Loss	Eoff	$V_{GE} = \pm 15V, R_{G} = 1.8\Omega$	_	500	_	mJ
(Note 1)	Diode Loss	Edsw	$I_F = 1200A, V_{GE} = -15V$ di / dt = 4000A / μ s, $V_{CC} = 900V$	_	300	_	mJ
Thermal Resistance		K+h (: a)	Transistor (IGBT) Stage	_	_	0.018	°C/W
			Diode Stage	_	_	0.035	°C/W

(Note 1) Test circuit and timing chart of switching time, reverse recovery time and switching dissipation.

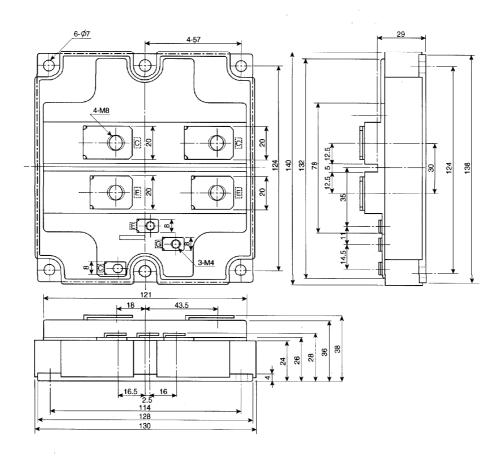






OUTLINE DRAWING

Unit: mm



Weight: 900g (Typ.)